

Erratum to: Acceleration Effect

Dale P. Barkey

Erratum to:
Chapter 3 in: K. Kondo et al. (eds.), *Copper Electrodeposition for Nanofabrication of Electronics Devices*, DOI [10.1007/978-1-4614-9176-7_3](https://doi.org/10.1007/978-1-4614-9176-7_3)

The material at the end of Chapter 3 (text on pages 56, 57, and top of 58 at the end of section 3.4) should not be regarded as part of the chapter and was inserted without the knowledge or consent of the author.

The online version of the original chapter can be found under DOI [10.1007/978-1-4614-9176-7_3](https://doi.org/10.1007/978-1-4614-9176-7_3)

D. P. Barkey (✉)
Department of Chemical Engineering, College of Engineering and Physical Science,
Kingsbury Hall, Room W305, Durham, NH 03824, USA
e-mail: dpb@cisunix.unh.edu